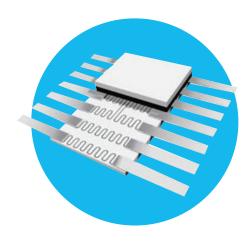
Resistors

TaNFilm® Precision **Flat Pack Networks**

8900 Series

- Precision absolute and ratio tolerances available
- Qualified to MIL-PRF-83401 /03, /10 and /15
- Qualified to characteristics M, K and H
- Custom schematics readily available
- Absolute TCR to ±15ppm/°C





All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

TaNFilm® resistor networks are designed for use in applications requiring a high degree of reliability, stability, tight tolerance and TCR tracking, and low noise. The sputtering process for resistor formation has been perfected to allow a continuous feed production line under high vacuum conditions, thus, insuring uniformity of properties between networks. Laser trimming makes tight ratios easily achievable. The gold plated copper leads are solid phase welded to a large area of gold conductor pads on the ceramic substrate assuring the most reliable termination and long term stability. The Tantalum Nitride resistor material is passivated for environmental protection insuring excellent performance far superior to military requirements.

Our TaNFilm® process enables us to manufacture networks containing different resistance values and still maintain tight tolerances and tracking characteristics. The nature of our photo-etch process makes it readily adaptable to meet each individual customer's needs. Custom circuit designs and special mechanical configurations can be easily achieved with a modest set up charge while maintaining our high standards of precision and reliability.

Electrical Data

Schematic	Resistance Range (Ω)	Range Absolute TCR Ratio (npm/°C)		Tracking TCR (ppm/°C)	Element Power (mW)			
	10 - 49.9	F, G, J	F, G	±50; ±100; ±300	±20			
	50.0 - 199	F, G, J	D, F, G	±25; ±50; ±100; ±300	±10			
А	200 - 999 B, D, F, G, J		A, B, D, F, G	±25; ±50; ±100; ±300	±5	50		
	1.0K - 100K	B, D, F, G, J	T, Q, A, B, D, F, G	D, F, G ±15; ±25; ±50; ±100; ±300				
	101K - 200K	B, D, F, G, J	A, B, D, F, G	±25; ±50; ±100; ±300	±5			
В	50 - 149	B, D, F, G, J	B, D, F, G	±300; ±100	±50			
	150 - 499	B, D, F, G, J	B, D, F, G	±300; ±100; ±50	±20	0.5		
	500 - 999	B, D, F, G, J	B, D, F, G	±25; ±50; ±100; ±300	±5	25		
	1.0K - 150K	B, D, F, G, J	B, D, F, G	±15; ±25; ±50; ±100; ±300	±5			





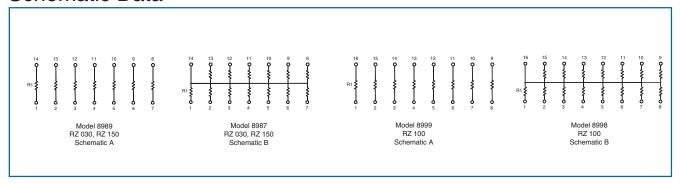
MIL-PRF-83401 Qualification Data

Specification Size		Schematic	Resistance Range (Ω)	Absolute Tolerance (%)	Characteristic		
MIL-PRF-83401/03	14-Pin	A, B	20 - 121K	F, G, J	K, M		
MIL-PRF-83401/15	14-PIN	A, D	100 - 100K	B, D, F, G, J	Н, К, М		
MIL-PRF-83401/10	16-Pin	A, B	100 - 100K	B, D, F, G, J	Н, К, М		

Package Specification Data (MIL and Commercial)

Schematic	Package Power (mW)		Power Derating	Voltage Rating	Temperature Range	Substrate	Lead Finish	Noise	
Concinatio	14-pin	n 16-pin							
А	350	400	100% from 0°C to 70°C derated linearly to 0%	√PxR not to exceed 50V	-65°C to +125°C	99.6% Alumina	Gold Plate (60/40 Sn/Pb available)	<-30dB	
В	325	375	at 125°C	exceed 50V			avaliable)		

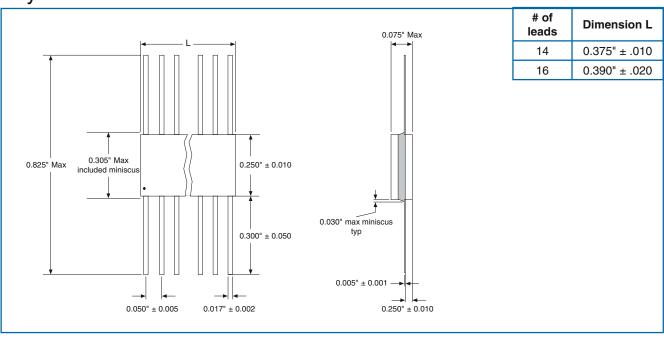
Schematic Data



8900 Series



Physical Data



Environmental Data

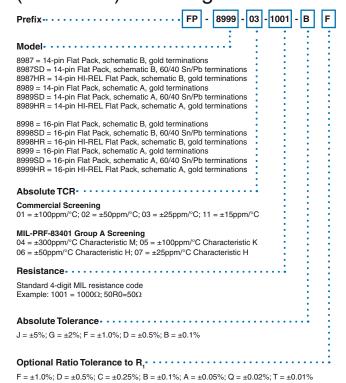
Teet year MIL DDC 92401	MI	L-PRF-8340	1 Limits (∆F	TaNFilm [®] Test Data (∆R%)		
Test per MIL-PRF-83401	M	K	Н	V	Max	Typical
Thermal Shock and Power Conditioning	0.7	0.7	0.5	0.25	0.1	0.02
Low Temperature Operation	0.5	0.25	0.1	0.1	0.1	0.01
Short Term Overload	0.5	0.25	0.1	0.1	0.05	0.01
Terminal Strength	0.25	0.25	0.25	0.1	0.1	0.01
Resistance to Solder Heat	0.25	0.25	0.1	0.2	0.1	0.02
Moisture Resistance	0.5	0.5	0.4	0.25	0.1	0.03
Shock	0.25	0.25	0.25	0.25	0.1	0.03
Vibration	0.25	0.25	0.25	0.1	0.1	0.03
Life	2.0	0.5	0.5	0.1	0.1	0.03
High Temperature Exposure	1.0	0.5	0.2	0.1	0.1	0.03
Low Temperature Storage	0.5	0.25	0.1	0.1	0.1	0.02
25°C Double Load	2.0	0.5	0.5	0.1	0.05	0.03

TaNFilm® Precision Flat Pack Networks





Commercial and MIL-Screened (Non-QPL) Ordering Data



Notes

HI-REL models include a precap inspection and thermo-compression bonded leads. TCR codes 01, 02, 03, and 11 are not available on HI-REL models. Custom schematics and screening available. Contact factory for ordering information.

MIL-PRF-83401 Ordering Data

Prefix · · · · · · · · · · · · · · · · · · ·	M83401	C)3	Κ		1001		F	Α
Specification Sheet 03 = 14-pin Flat Pack 10 = 16-pin Flat Pack 15 = 14-pin HI REL Flat Pack	• • • • • •	••	•	•					
Characteristic M, K, H	• • • • • •	• •	• • •	.:		•			
Resistance · · · · · · · · ·									
Standard 4-digit MIL resistance of Example: $1001 = 1000\Omega$; $50R0 = 1000\Omega$									
Absolute Tolerance • • • •	• • • • • •		• • •		•	• • • • •	•	•	
$J = \pm 5\%$; $G = \pm 2\%$; $F = \pm 1.0\%$; D	= ±0.5%; B	= ±0	0.1%						
Schematic · · · · · · · ·									• • •

A = Isolated; B = Bussed Schematic

Standard lead termination is gold plate. Contact factory for optional 60/40 Sn/Pb hot solder dip finish.

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M8340107K1471FGD03 M8340108K1001FCD03 M8340108K2402GGD03 M8340108K3240FGD03 M8340108K3242FGD03

M8340108K3322FCD03 M8340108K4991FGD03 M8340108K6192FGD03 M8340108K6202GGD03 M8340109K2002FCD03

M8340109M4701GCD03 EXB-24N121JX EXB-24N330JX EXB-24N470JX EXB-A10E102J EXB-A10E104J 744C083101JTR EXB-U14360JX EXB-U18240JX EXB-U18390JX MDP1603100KGE04 PRA100I2-1KBWNW GUS-SS4-BLF-01-1002-G

ACAS06S0830339P100 ACAS06S0830343P100 ACAS06S0830344P100 RM2012A-102/104-PBVW10 RM2012A-102503-PBVW10

RM2012A-502104-PBVW10 RM3216B-102302-PBVW10 L091S102LF ACAS06S0830341P100 ACAS06S0830342P100

ACAS06S0830345P100 EXB-14V300JX EXB-U14220JX EXB-U14470JX EXB-U18330JX EXB-V4N100JV EXB-V8V220GV PRA100I2-10KBWN PRA100I4-10KBWN CSC09A014K70JEK M8340102M4701JAD04 M8340105K1002GGD03